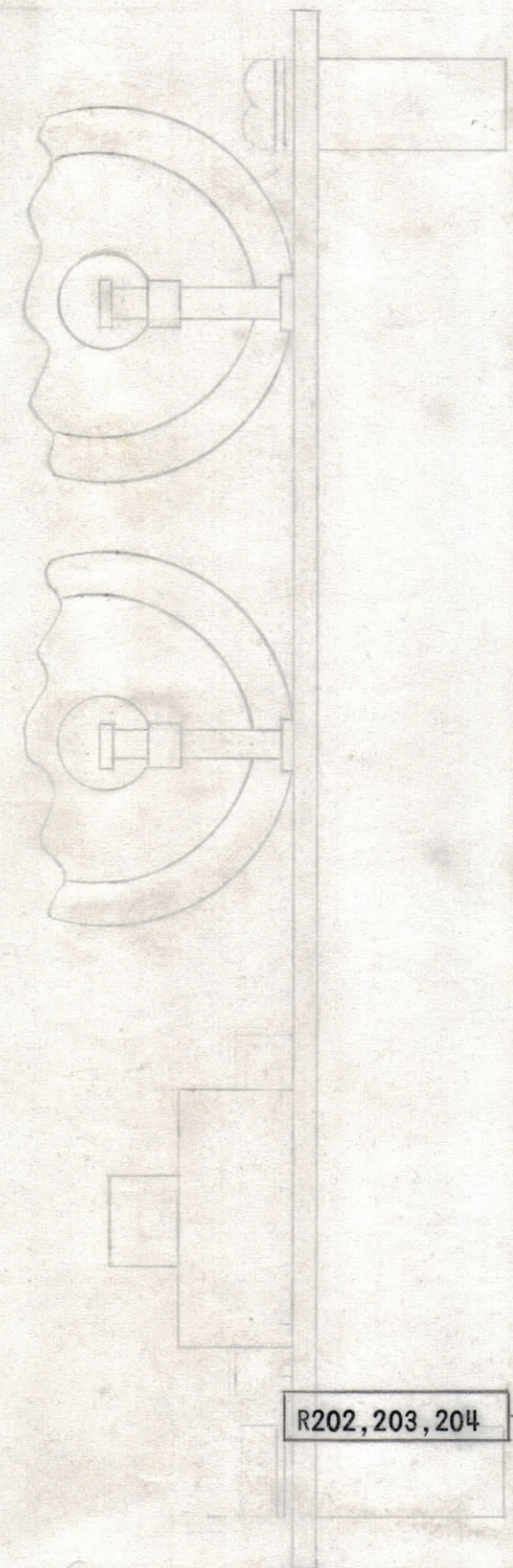
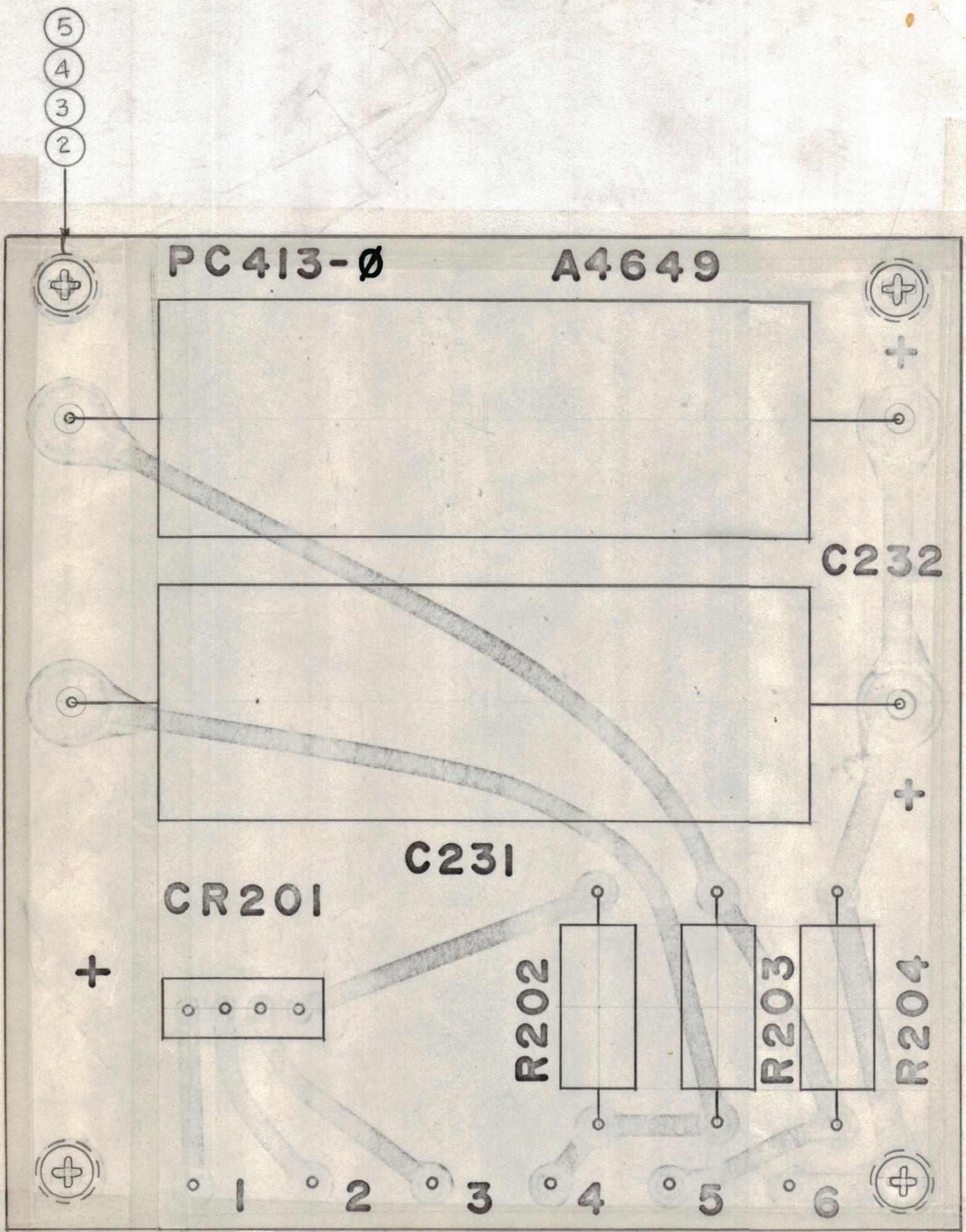


REVISIONS						
ZONE	LTR	DESCRIPTION	DATE	E.M.N.NO	DRAFT	CHKD APPD
	X	EXP. RELEASE	11-3-67			HSZ
	Ø	ORIGINAL RELEASE FOR PROD.	9-19-68			HSZ



QTY. REQ.	ITEM	PART NO.	DESCRIPTION	SYMBOL
X	9	BS100	SOLDER, TIN ALLOY	
3	8	SEE NOTE 4	RESISTOR, FIXED COMPOSITION	
1	7	SEE NOTE 4	SEMICONDUCTOR, DEVICE DIODE	CR201
2	6	SEE NOTE 4	CAPACITOR, FIXED ELECTROLYTIC	C231, 232
4	5	TE135-3	NUT, PLAIN RD	
4	4	LWEO6MRN	WASHER, LOCK EXTERNAL	
4	3	FWO6HBN	WASHER, FLAT	
4	2	SCBP0632BN5	SCREW, MACHINE	
1	1	PC413	PRINTED CIRCUIT BOARD	

ASSEMBLY NOTICE

1. TO MOUNT COMPONENTS INSERT LEAD THROUGH PLATED THRU-HOLES.
2. USE CAUTION WHEN APPLYING HEAT & SOLDER TO LEAD AND FOIL.
3. CLEAN AND INSPECT AS PER S676.
4. FOR ELECTRICAL COMPONENT PART NUMBERS REFER TO NPL A4649
5. USE SYMBOL NUMBERS FOR ASSEMBLY REFERENCE.

1	BCT-10KA	
1	GPT-10KLF	
QTY / UNIT	MODEL USED ON	ASS'Y NO.
APPLICATION		
	CODE A	S401-451

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UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES

TOLERANCES ON
 DECIMALS .X ± .05
 .XX ± .01
 .XXX ± .005
 FRACTIONS ± 1/64
 ANGLES ± 0° -30'

FINAL APPROVAL	DATE
Mech. Des.	DATE
ELECT. DES.	DATE
CHECKED	DATE
DRAWN	DATE

THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK			
ASSEMBLY, PRINTED CIRCUIT BOARD			
SIZE	CODE IDENT. NO.	DWG NO.	ISSUE
C	82679	A 4649	Ø
SCALE 2:1		SHEET OF	